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FSA8009 Audio Jack Send / End Detection with MIC / Video Switch

Features

| | Accessory Plug-In |
|-----------------------|-------------------------|
| Detection | 3- or 4-Pole Audio Jack |
| | Send / End Key Pressed |
| Switch Type | Microphone & Video |
| V_{DD} | 2.5 to 4.3 V |
| THD (MIC) | 0.01% Typical |
| ESD (Air Gap) | 16 kV |
| Operating Temperature | -40°C to 85°C |
| | 10-Lead UMLP |
| Package | 1.4x1.8x0.5 mm, 0.4 mm |
| | Pitch |
| Top Mark | KP |
| Ordering Information | FSA8009UMX |

Applications

- 3.5 mm and 2.5 mm Audio Jacks
- Cellular Phones, Smartphones
- MP3 and PMP

Description

The FSA8009 is an audio jack microphone / video switch for 3- or 4-pole accessories with send / end (S/E) detection. In addition to detection, the FSA8009 features an integrated microphone / video switch that allows the processor to configure the audio jack. The architecture is designed to allow common third-party headphones to be used for listening to music from mobile handsets, personal media players, and portable peripheral devices.

- Determines When Send / End Button Key is Pressed
- Integrates a MIC / Video Switch for 4-Pole Configuration
- Reduces Pop / Click Caused by Microphone Bias

Related Resources

- For samples and questions, please contact: Analog.Switch@fairchildsemi.com.
- FSA8009 Demonstration Board

Typical Application

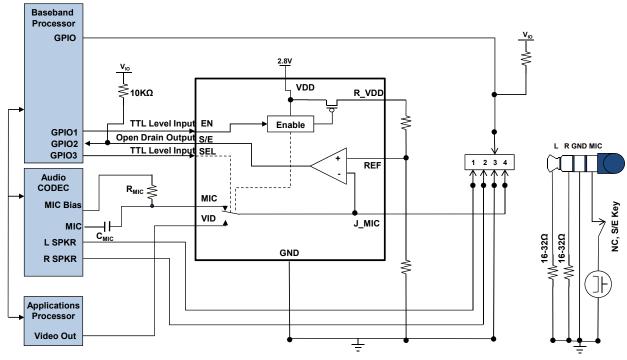


Figure 1. Mobile Phone Example

Pin Descriptions

| Name | Pin# | Type | Description | | | | | |
|-------|------|---------|---|---------|--------------------------------|--|--|--|
| R_VDD | 1 | Output | Optional pull-up voltage, with a resistor divider, sets the reference voltage on the REF pin | | | | | |
| EN | 2 | lpput | Device enable, low-power mode | | Device inactive ⁽¹⁾ | | | |
| □IN | 2 | Input | | | Device active ⁽¹⁾ | | | |
| CEL | 3 | lanut | MIC (VID quitab calcat hin | 0 | $VID = J_MIC^{(1)}$ | | | |
| SEL | 3 | Input | MIC / VID switch select pin | 1 | MIC = J_MIC ⁽¹⁾ | | | |
| C/F | 4 | Outroit | Indicates state of send /end key press, open-drain output requires | | Press ⁽¹⁾ | | | |
| S/E | 4 | Output | pull-up resistor | 1 | No key press ⁽¹⁾ | | | |
| VID | 6 | Switch | Video switch path; connects between video source and audio jack m | icroph | one pin | | | |
| VDD | 5 | Power | Supply voltage | | | | | |
| MIC | 7 | Switch | Microphone switch path that goes to the CODEC microphone amplifi | er inpu | ut | | | |
| J_MIC | 8 | Switch | Microphone switch path that connects to the microphone, SEND/ENI | D key, | and jack pole video | | | |
| REF | 10 | Input | Reference voltage used to detect a send / end key press, through a resistor divider off R_VDD or external voltage reference | | | | | |
| GND | 9 | Ground | Ground for both the audio jack and the PCB | | | | | |

Note:

1. $0 = V_{OL}$ or V_{IL} ; $1 = V_{OH}$ or V_{IH} .

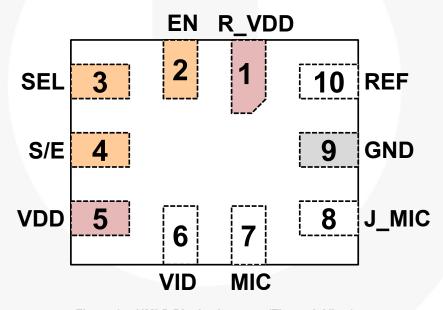


Figure 2. UMLP Pin Assignment (Through View)

Table 1. Device Configuration in Reset and Active States

| EN | SEL | MIC | VID | R_VDD | S/E |
|----|-----|---------|---------|-------|--------|
| 0 | X | 3-State | 3-State | GND | HIGH |
| 1 | 1 | J_MIC | Open | VDD | Active |
| 1 | 0 | Open | J_MIC | GND | LOW |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | | Min. | Max. | Units | |
|------------------|--|--|------|----------------------|-------|--|
| V_{DD} | Supply Voltage from Battery | | -0.5 | 5.5 | V | |
| V_{SW} | Switch I/O Voltage | | -0.5 | V _{DD} +0.5 | V | |
| I _{IK} | Input Clamp Diode Current ⁽²⁾ | | -50 | | mA | |
| I _{SW} | Switch I/O Current (Continuous) ⁽²⁾ | | | 50 | mA | |
| T _{STG} | Storage Temperature Range | | | +150 | °C | |
| TJ | Maximum Junction Temperature | | | +150 | °C | |
| TL | Lead Temperature (Soldering, 10 Seconds) | | | +260 | °C | |
| | IFC 64000 4.2 System | Air Gap | 16 | | | |
| | IEC 61000-4-2 System | Contact | 10 | | | |
| ESD | | All other Pins | 6 | | kV | |
| 230 | Human Body Model, JEDEC JESD22-A114 | J_DET, J_MIC, V _{DD} , V _{IO} , GND | 8 | | • | |
| | Charged Device Model, JEDEC JESD22-C101 | All Pins | 2 | | | |

Note:

2. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Min. | Max. | Units |
|----------------|------------------------|------|------|-------|
| V_{DD} | Battery Supply Voltage | 2.5 | 4.3 | V |
| T _A | Operating Temperature | -40 | +85 | °C |

DC Electrical Characteristics

All typical values are at T_A =25°C unless otherwise specified.

MIC Switch

| Cumbal | Parameter | V 00 | Conditions | T _A = | Units | | |
|-----------------------|--|---------------------|---|------------------|-------|----------|--------|
| Symbol | i didilietei | V _{DD} (V) | Conditions | Min. | Тур. | Max. | Ullits |
| | | 2.8 | | | 2.0 | 4.0 | |
| Б | R _{ON} MIC Switch On Resistance | 3.0 | - 24 m \ \/ - 2 2 \/ | | 1.5 | 3.5 | |
| KON | WIC SWICH OH RESISTANCE | 3.3 | I_{OUT} = 24 mA, V_{IN} = 2.2 V | | 1.2 | 3.0 | Ω |
| | | 3.8 | | | 1.0 | 2.5 | |
| | On Desigtance Flatness | 2.8 | I _{OUT} = 24 mA, V _{IN} = 1 V to V _{DD} | | 0.7 | 1.5 | Ω |
| D | | 3.0 | | | 0.6 | 1.4 | |
| R _{FLAT(ON)} | On Resistance Flatness | 3.3 | | | 0.5 | 1.3 | |
| | | 3.8 | | | 0.5 | 1.2 | |
| V _{IN} | Switch Input Voltage Range | 2.5 to 4.3 | | 0 | | V_{DD} | V |
| C _{ON} | MIC and J_MIC Switch ON Capacitance | 2.8 | f = 1 MHz | | 15 | | pF |
| C _{OFF} | MIC and J_MIC Switch OFF Capacitance | 2.8 | f = 1 MHz | | 8 | | pF |

Video Switch Characteristics

| Cumbal | Davamatav | V _{DD} (V) | Conditions | $T_A = -40 \text{ to } +85^{\circ}\text{C}$ | | | Unit |
|-----------------------|--|---------------------|--|---|------|------|------|
| Symbol | Parameter | | Conditions | Min. | Тур. | Max. | Unit |
| | | 2.8 | | | 1.0 | 1.5 | |
| D | R _{ON} MIC Switch On Resistance | 3.0 | I _{OUT} = 24 mA, V _{IN} = 0.5 V | | 0.9 | 1.4 | Ω |
| KON | | 3.3 | 10UT - 24 IIIA, VIN - 0.5 V | | 8.0 | 1.3 | 12 |
| | | 3.8 | | | 0.7 | 1.2 | |
| | | 2.8 | I _{OUT} = 24 mA, V _{IN} = 0 V to | | 0.4 | 0.60 | Ω |
| В | On Registance Flatness | 3.0 | | | 0.3 | 0.55 | |
| R _{FLAT(ON)} | On Resistance Flatness | 3.3 | 1.2 V | | 0.2 | 0.50 | |
| | | 3.8 | | | 0.15 | 0.45 | |
| V _{IN} | Switch Input Voltage Range | 2.5 to 4.3 | | 0 | | 1.5 | V |
| C _{ON} | VID Switch ON Capacitance | 2.8 | f = 1 MHz | | 40 | · | pF |
| C _{OFF} | VID Switch OFF Capacitance | 2.8 | f = 1 MHz | | 10 | | pF |

Parallel I/O

| Symbol | Parameter | T _A = | Heit | | |
|--------------------|---|------------------------|------|------------------------|------|
| | Parameter | Min. | Тур. | Max. | Unit |
| V _{IH} | Input High Voltage (EN, SEL) | 0.44 x V _{DD} | | V_{DD} | V |
| V_{IL} | Input Low Voltage (EN, SEL) | GND | | 0.15 x V _{DD} | V |
| PUR _{S/E} | Pull-Up Resistor on S/E | 2 | | 110 | ΚΩ |
| V _{OL} | Output Low Voltage (S/E) (V _{PUR} = Voltage of Pull-Up Resistor) | | | 0.2 x V _{PUR} | V |

DC Electrical Characteristics (Continued)

All typical values are at T_A =25°C unless otherwise specified.

Comparator NC Switch

| Symbol | Parameter | V _{DD} (V) | Conditions | $T_A = -40 \text{ to } +85^{\circ}\text{C}$ | | | Hnit |
|--------------------|--------------------------------------|---------------------|------------|---|------|-------------------------|------|
| | Parameter | | Conditions | Min. | Тур. | Max. | Unit |
| V_{REF} | Input Voltage on REF Pin | | | 1 | | V _{DD} – 0.075 | V |
| COM _{HYS} | Hysteresis of Comparator "-" Termina | al | | | 50 | | mV |

Current

| Cymhol | Parameter | V 00 | Conditions | T _A = | Unit | | |
|---------------------|--------------------------------|---------------------|---|------------------|------|------|-------|
| Symbol | | V _{DD} (V) | | Min. | Тур. | Max. | Ullit |
| I _{OFF} | Off-State Leakage Current | 4.3 | J_MIC = 1 V, 4.3 V MIC or VID = 4.3 V, 1 V | -15 | | 15 | nA |
| I _{IN} | Input Leakage Current | 0 to 4.3 | Inputs 0 to 4.3 V | | | 1 | μΑ |
| I _{CC-EN} | Low-Power Mode | 2.5 to 4.3 | EN = LOW | | 10 | | nA |
| I _{CC-VID} | Current during Video Mode | 2.5 to 4.3 | Active Current (EN = HIGH, SEL = LOW) | | 10 | | nA |
| I _{CC-MIC} | Current during Microphone Mode | 2.5 to 4.3 | Active Current (EN = HIGH, SEL = HIGH) | | 20 | | μΑ |

AC Electrical Characteristics

All typical values are for V_{CC} =3.3 V at T_{A} =25°C unless otherwise specified.

MIC Switch

| Symbol | Parameter | V _{DD} (V) | Conditions | T _A = -40 to +85°C | | | Heit |
|-------------------|---------------------------|---------------------|---|-------------------------------|------|------|------|
| | | | | Min. | Тур. | Max. | Unit |
| THD | Total Harmonic Distortion | 2.8 | $R_T = 600 \Omega$, $V_{SW} = 0.5 V_{PP}$, $f = 20 Hz$ to 20 kHz, $V_{IN} = 2.2 V$ | | .003 | | % |
| O _{IRR} | Off Isolation | 2.8 | f = 20 kHz, R _S =32 Ω , C _L =0 pF, R _T =32 Ω | | -100 | | dB |
| X _{TALK} | Crosstalk from MIC to VID | 2.8 | f = 100 MHz, R _L =100 Ω | | -67 | | dB |

Video Switch Characteristics

| Cumbal | Davamatav | V 00 | Conditions | T _A = -40 to +85°C | | | linit |
|-------------------|---------------------------|---------------------|--|-------------------------------|------|------|-------|
| Symbol | Parameter | V _{DD} (V) | Conditions | Min. | Тур. | Max. | Unit |
| D_G | Differential Gain | 2.8 | R _L = 150 Ω, f = 3.58 MHz | | .09 | | % |
| D _P | Differential Phase | 2.8 | R _L = 150 Ω, f = 3.58 MHz | | .13 | | 0 |
| O _{IRR} | Off Isolation | 2.8 | f=10 MHz, R _L =150 Ω, | | -45 | | dB |
| X _{TALK} | Crosstalk from VID to MIC | 2.8 | f=10 MHz, R_{IN} = 10 Ω, C_L =0 pF, R_L =150 Ω | | -65 | | dB |

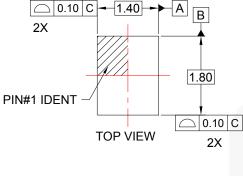
Parallel I/O

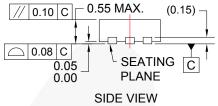
| С. | mbal | Doromotor | V AA | Conditions | $T_A = -40 \text{ to } +85^{\circ}\text{C}$ | | | l lmi4 |
|------------------|------------------|---|---------------------|--|---|------|------|--------|
| Symbol | | Parameter | V _{DD} (V) | Conditions | Min. | Тур. | Max. | Unit |
| | t _{BBM} | Break-Before-Make Time | 2.5 to 4.3 | | | 120 | | ns |
| | t _{EN} | Enable or Disable Time | 2.5 to 4.3 | EN LOW→ HIGH or EN HIGH→LOW | | 15 | | μs |
| t _{SEI} | L-COM-ON | Select to Comparator On | 2.5 to 4.3 | SEL LOW→ HIGH to Comparator ON | | 10 | | μs |
| t _{SEL} | COM-OFF | Select to Comparator Off | 2.5 to 4.3 | SEL HIGH→LOW to Comparator OFF | | 20 | | ns |
| | t _{ON} | Switch Turn-On Time | 2.5 to 4.3 | | | 40 | | ns |
| | t _{OFF} | Switch Turn-Off Time | 2.5 to 4.3 | | | 15 | | ns |
| t _{J_} | _MIC-S/E | Propagation Delay from Comparator Trigger to S/E Output | 2.5 to 4.3 | J_MIC > REF from LOW→HIGH J_MIC < REF from HIGH→LOW | | 10 | | μs |

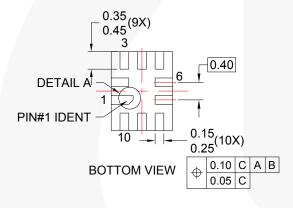
Power

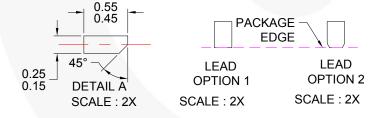
| Symbol | Parameter | V _{DD} (V) | Conditions | $T_A = -40 \text{ to } +85^{\circ}\text{C}$ | | | Unit |
|----------|------------------------------|---------------------|--|---|------|------|------|
| Syllibol | | | Conditions | Min. | Тур. | Max. | Onit |
| PSRR | Power Supply Rejection Ratio | 2.8 | Power Supply Noise 300 mV _{PP} , Measured 10/90%, f=217 Hz | | -100 | | dB |

Physical Dimensions

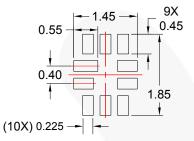








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Figure 3. 10-Lead UMLP Package Drawing

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Ordering Information

| Part Number | Operating Temperature Range | Top Mark | Package |
|-------------|-----------------------------|----------|--|
| FSA8009UMX | -40 to +85°C | I KP | 10-Lead 1.4 x 1.8 x 0.55 mm, 0.4 mm Pitch, Ultrathin Molded Leadless Package (UMLP) |





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